

SSC8L610PN6

N-Channel Enhancement Mode MOSFET

Features

V _{DS}	V _{GS}	R _{DS(ON)} Typ.	ID
60V	±20V	5.5mΩ@10V	76A
	<u> </u>	8mΩ@4.5V	

> Description

This device is N-Channel enhancement MOSFET. Uses SGT technology and design to provide excellent RDSON with low gate charge. This device is suitable for use in DC-DC conversion, power switch and charging circuit.

100% UIS + ΔVDS + Rg Tested!

- Applications
- Motor Drive Control
- DCDC Conversion
- Power Supplies
- Synchronous Rectification

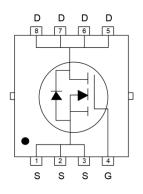
> Ordering Information

Device	Package	Shipping
SSC8L610PN6	PDFN5X6-8L	5000/Reel

> Pin Configuration



PDFN5X6-8L (Top View)



Pin Configuration



Marking

(XXYY: Internal Traceability Code)





Symbol	Parameter	Ratings	Unit	
V _{DSS}	Drain-to-Source Voltage		60	V
V _{GSS}	Gate-to-Source Volta	Gate-to-Source Voltage		V
	Continuous Drain Current ^d	Tc =25 ℃	76	
ID		Tc=100℃	48	A
	Continuous Drain Current ^a	T _A =25℃	14	•
IDSM		T , =70 ℃	11	A
Ідм	Pulsed Drain Current ^b		304	Α
_		Tc =25 ℃	69	w
PD	Power Dissipation ^c	Tc=100℃	27	
Розм	Power Dissipation ^a	T _A =25℃	2.6	w
		T , =70 ℃	1.6	
las	Avalanche Current ^b L=0.5mH Single Pulse		22	Α
Eas	Avalanche Energy ^b L=0.5mH Single Pulse		121	mJ
TJ	Operation junction temperature		-55~150	*
Tstg	Storage temperature ra	-55~150	°C	

> Absolute Maximum Ratings ($T_A=25^{\circ}C$ unless otherwise noted)

➤ Thermal Resistance Ratings (T_A=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Max.	Unit
Reja	Junction-to-Ambient Thermal Resistance ^a	49	60	°C/W
R _{θJC}	Junction-to-Case Thermal Resistance	1.8	2.5	C/VV

Note:

- a. The value of R_{θJA} is measured with the device mounted on 1 in² FR-4 board with 2oz.copper, in a still air environment with T_A=25 °C.The value in any given application depends on the user is specific board design. The power dissipation is based on the t≤10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation P_D is based on T_{J(MAX)}=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
- d. The maximum current rating is package limited.



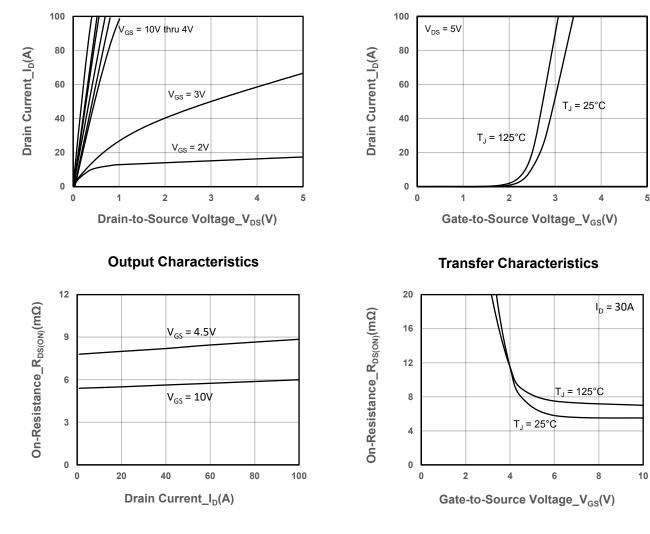


\succ Electrical Characteristics (T_A=25 $^\circ\!\!\!\!{}^\circ\!\!\!{}^\circ$ unless otherwise noted)

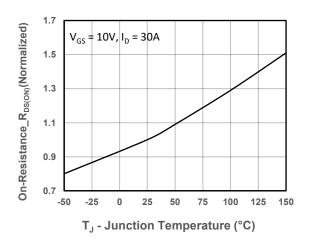
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	V _(BR) dss	V _{GS} = 0V, I _D = 250µA	60			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250 uA$	1.0	1.6	2.5	V
	D	V _{GS} = 10V, I _D = 20A		5.5	7.2	
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} = 4.5V, I _D = 10A		8	10.5	mΩ
Zero Gate Voltage Drain Current	loss	V _{DS} = 60V, V _{GS} = 0V			1	μA
Gate-Source Leak Current	lgss	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA
Transconductance	G _{FS}	V _{DS} = 5V, I _D = 10A		20		S
Forward Voltage	Vsd	V _{GS} = 0V, I _S = 10A		0.84	1.3	V
Gate Resistance	Rg	V _{DS} = 0V, f = 1MHz		1.3		Ω
Input Capacitance	Ciss			1384		
Output Capacitance	Coss	$V_{DS} = 30V, V_{GS} = 0V,$		412		pF
Reverse Transfer Capacitance	Crss	f = 1MHz		17		
Total Gate Charge	Q _G			24.8		
Gate to Source Charge	Q _{GS}	$V_{GS} = 10V, V_{DS} = 30V,$		4.5		nC
Gate to Drain Charge	Q _{GD}	- I _D = 30A		4.1		
Turn-on Delay Time	T _{D(ON)}			6.3		
Rise Time	Tr	V _{GS} = 10V, V _{DS} = 30V,		5.1		
Turn-off Delay Time	T _{D(OFF)}	I _D = 30A, R _G = 3Ω		22		ns
Fall Time	T _f]		9.1		
Diode Recovery Time	Trr	I _F =30A, di/dt=500A/us		40		ns
Diode Recovery Charge	Q _{rr}	I _F =30A, di/dt=500A/us		93.4		nC



➤ Typical Performance Characteristics (T_A=25[°]C unless otherwise noted)

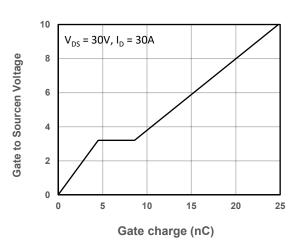


On-Resistance vs. Drain Current and Gate Voltage



On-Resistance vs. Junction Temperature

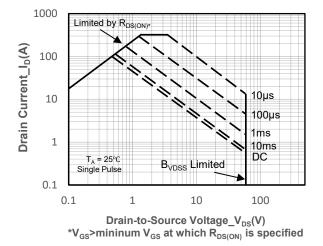
On-Resistance vs. Gate-to-Source Voltage



Gate-Source Voltage vs. Gate charge

4 / 7 Analog Future



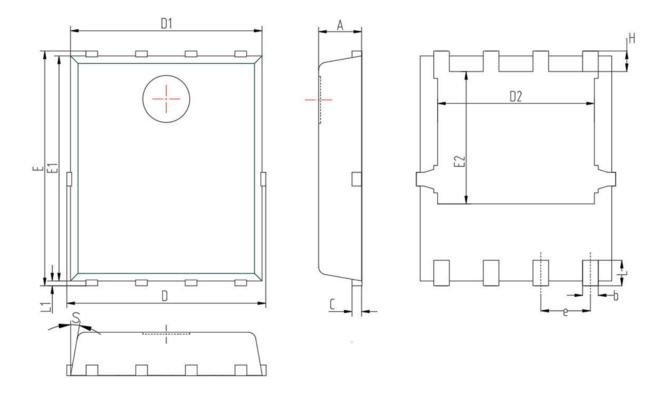


Safe Operating Area vs. Junction-to-Ambient





> Package Information



Symbol	MILL IMETER			
	Min	Nom	Max	
A	0.90	1.05	1.20	
b	0.25	0.30	0.51	
С	0.15	0.25	0.35	
D	4.80	5.10	5.40	
D1	4.80	5.00	5.20	
D2	3.70	4.00	4.30	
E	5.80	6.15	6.50	
E1	5.50	5.75	5.95	
E2	3.30	3.45	3.67	
е	1.27BSC			
Н	0.40	0.60	0.93	
L	0.45	0.65	0.85	
L1	0.00	0.10	0.25	
S	0°		12°	



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